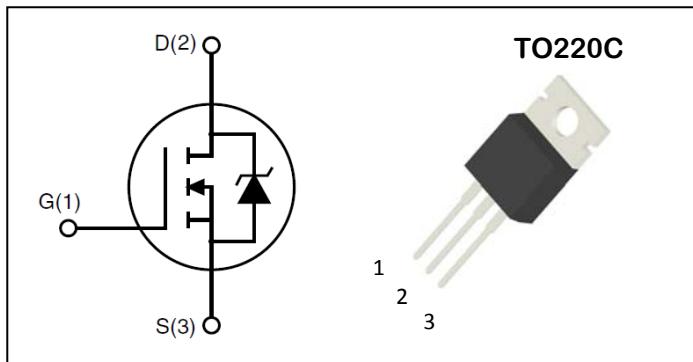


N-Channel Enhancement Mode Field Effect Transistor**PRODUCT SUMMARY**

V_{DSS}	I_D	$R_{DS(ON)}$ ($m\Omega$)
60V	198A	3.8m Ω

**Features:**

- Low gate input resistance
- High dv/dt and avalanche capabilities
- 100% EAS Guaranteed
- Advanced high cell density Trench technology
- Lead-Free, RoHS Compliant

Description:

The AM200N06 series MOSFETs is a new technology, which combines an innovative super junction technology and advance process. This new technology achieves low R_{dson} , energy saving, high reliability and uniformity, superior power density and space saving.

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise specified)

Symbol	Parameter	Ratings	Unit
Common Ratings			
V_{DSS}	Drain-Source Voltage	60	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current ^(1,6)	$T_C = 25^\circ C$	A
Mounted on Large Heat Sink			
I_{DM}	300 μs Pulse Drain Current Tested ⁽²⁾	$T_C = 25^\circ C$	A
I_D	Continuous Drain Current ^(1,3)	$T_C = 25^\circ C$	A
		$T_C = 100^\circ C$	A
P_D	Maximum Power Dissipation ⁽⁴⁾	$T_C = 25^\circ C$	W
	Maximum Power Dissipation ⁽⁴⁾	$T_A = 25^\circ C$	W

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max ⁽¹⁾	0.48	°C/W
R_{thJA}	Thermal resistance junction-ambient max ⁽¹⁾	62	°C/W

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =48V, V _{GS} =0V, T _J =25°C	--	--	1	uA
		V _{DS} =48V, V _{GS} =0V, T _J =55°C	--	--	5	
V _{G(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250A	2.5		4.5	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
R _{D(on)}	Drain-SourceOn-stateResistance ⁽²⁾	V _{GS} = 10V, I _{DS} =30A	--	3	3.8	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} = 15V, Frequency=1MHz	--	6655	--	pF
C _{oss}	Output Capacitance		--	1565	--	
C _{rss}	Reverse Transfer Capacitance		--	340	--	
Switching Characteristics						
t _{d(ON)}	Turn-on Delay Time	V _{DS} =30V, I _D = 48A, V _{GS} = 10V, R _{GEN} =3.3 Ω	--	33.6	--	ns
t _r	Turn-on Rise Time		--	40.6	--	
t _{d(OFF)}	Turn-off Delay Time		--	59	--	
t _f	Turn-off Fall Time		--	26.8	--	
Q _g	Total Gate Charge	V _{DS} =48V, V _{GS} = 10V, I _{DS} =15A	--	89	--	nC
Q _{gs}	Gate-Source Charge		--	32	--	
Q _{gd}	Gate-Drain Charge		--	18	--	
EAS	Single Pulse Avalanche Energy ⁽⁵⁾	V _{DD} =50V , L=0.1mH , I _{AS} =30A	78	--	--	mJ
Diode Characteristics						
V _{SD}	Diode Forward Voltage ⁽²⁾	I _{SD} = 30A, V _{GS} = 0	--	--	1.2	V
t _{rr}	Reverse Recovery Time	I _{SD} =30A, dI _{SD} /dt=100A/μs	--	46	--	ns
q _{rr}	Reverse Recovery Charge		--	52	--	nC

NOTES:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
3. Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Performance Characteristics

Figure 1: Normalized R_{DSON} v.s T_J

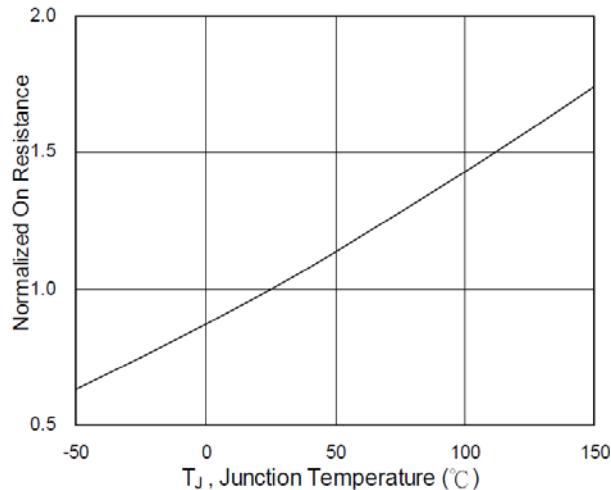


Figure 2: Gate-Charge Characteristics

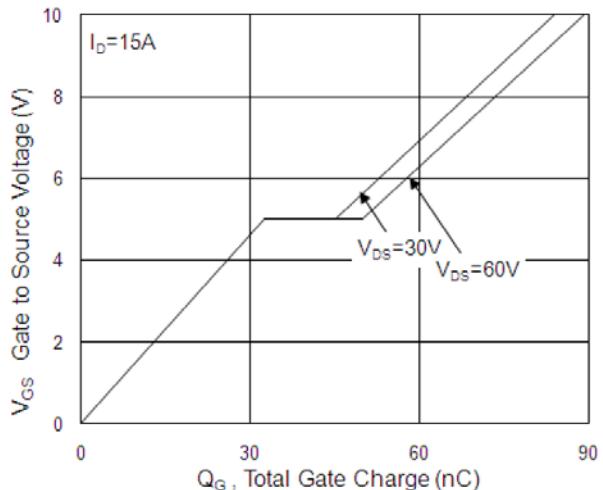


Figure 3: On-Resistance v.s Gate-Source

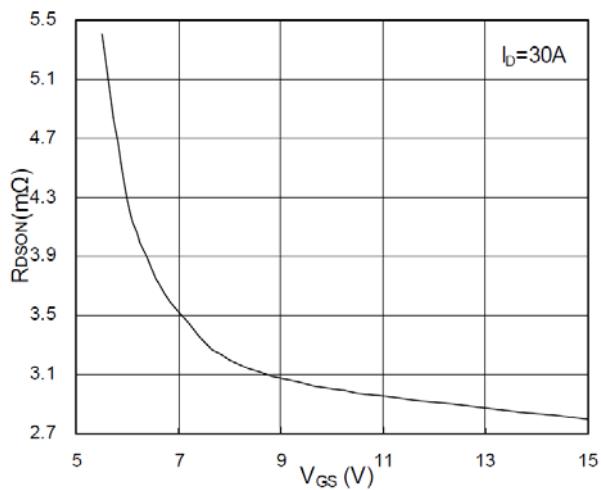


Figure 4: Typical Output Characteristics

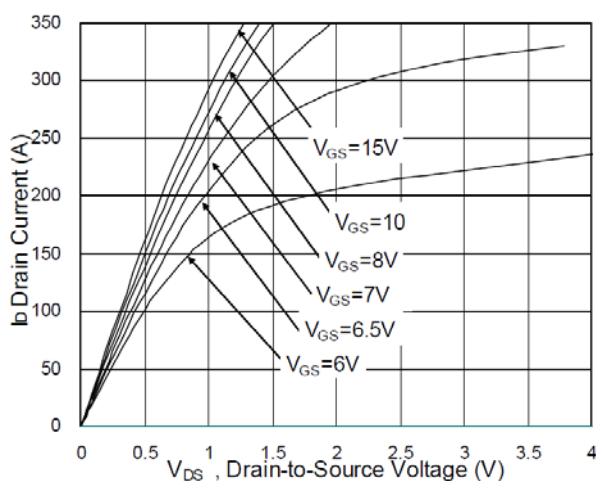


Figure 5: Normalized V_{GS(th)} v.s T_J

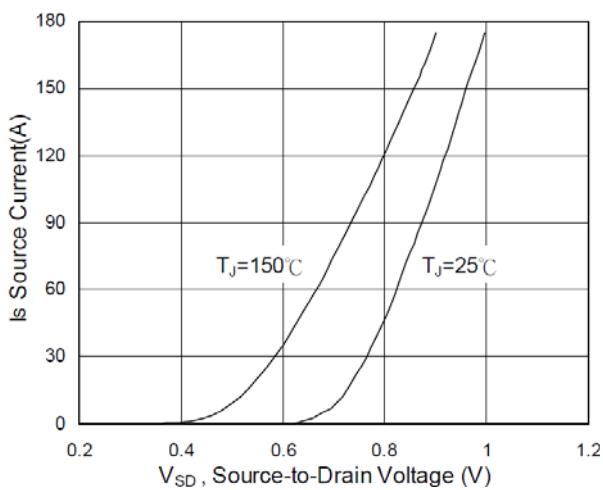


Figure 6: Drain-source on-state resistance

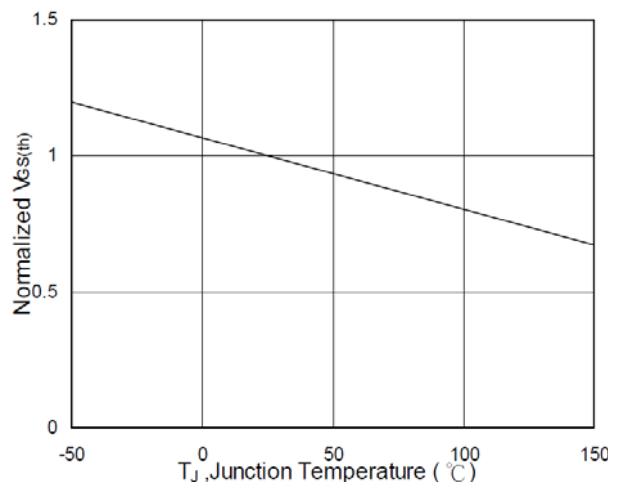
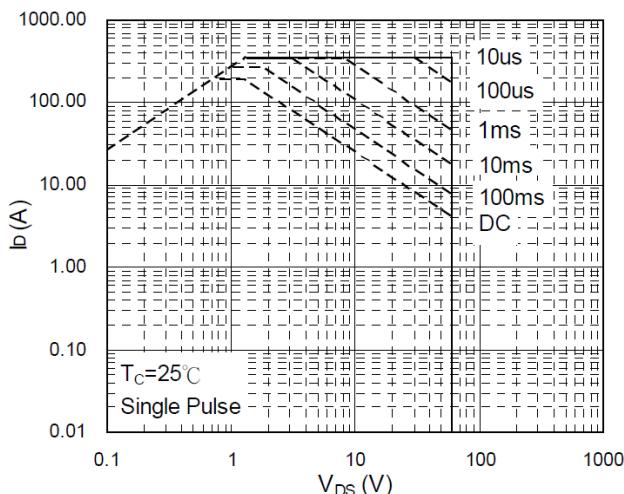
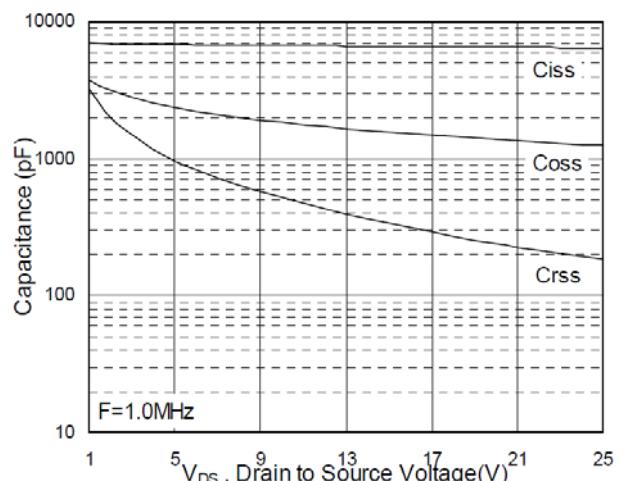
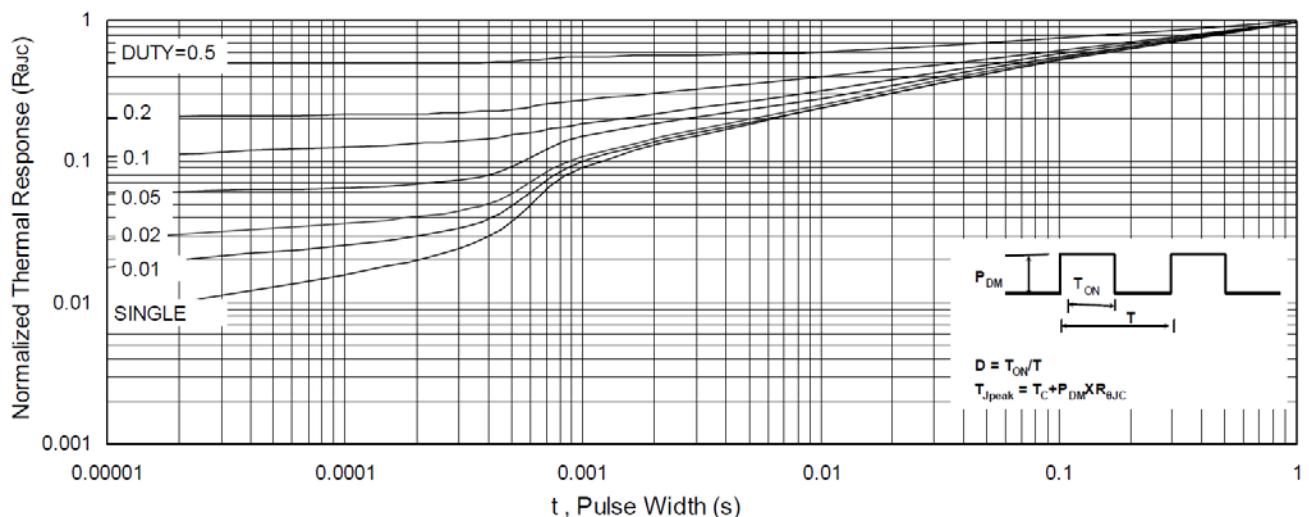
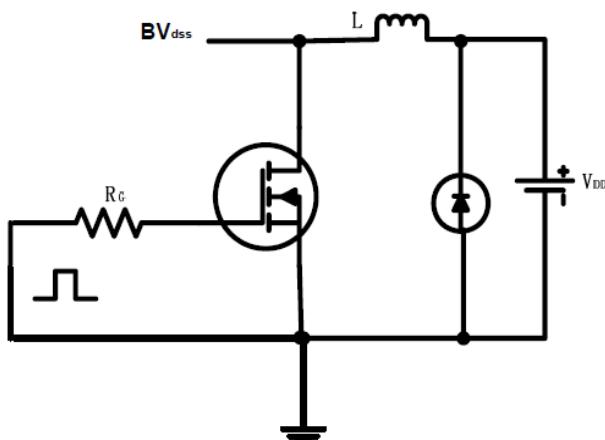


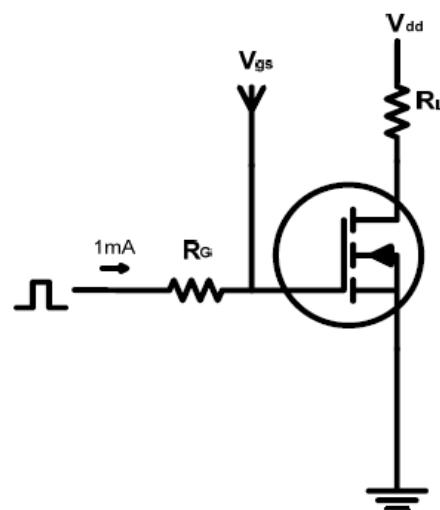
Figure 7: Safe Operating Area**Figure 8: Capacitance****Figure 9: Normalized Maximum Transient Thermal Impedance**

Test circuits and Waveforms

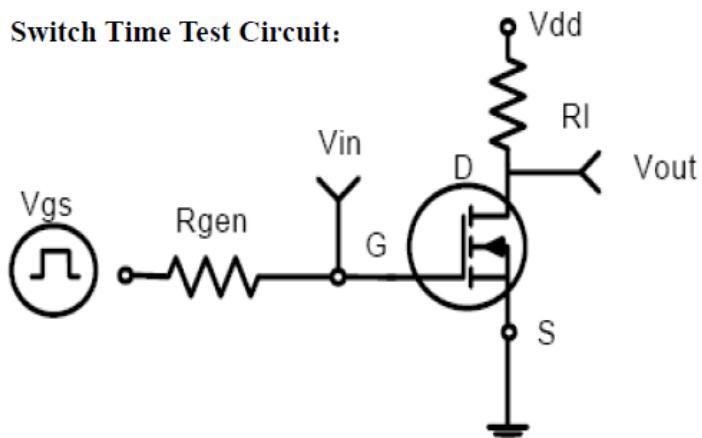
EAS test circuits:



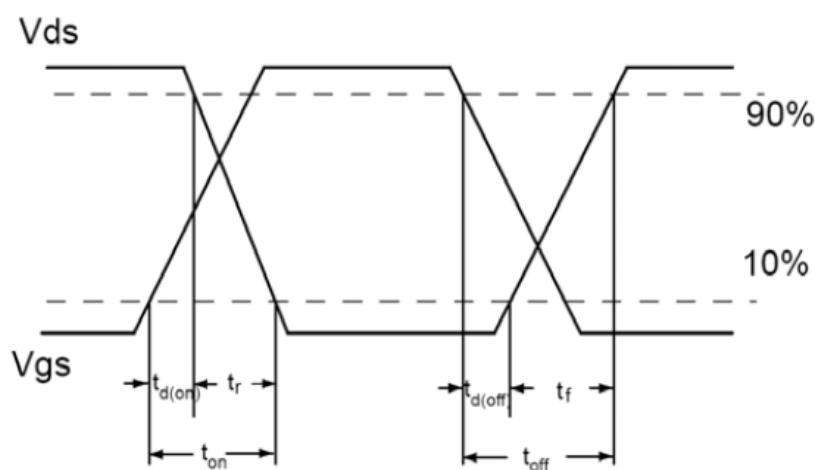
Gate charge test circuit:



Switch Time Test Circuit:

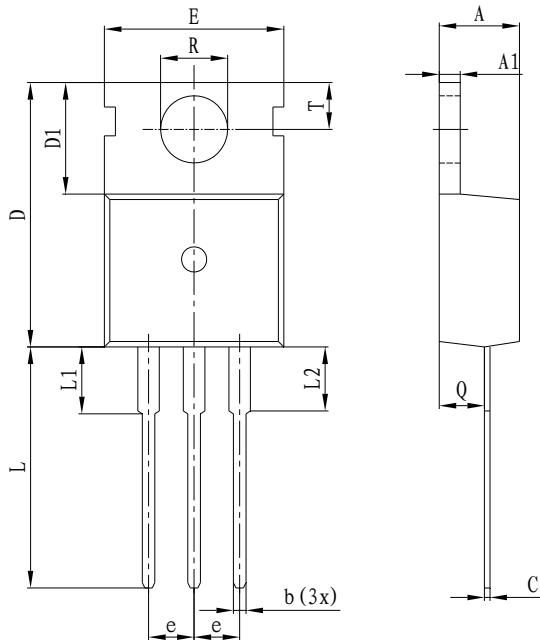


Switch Waveforms:



PACKAGE MECHANICAL DATA

TO-220C Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
e	2.54	TYP	0.099	TYP
A	4.10	4.70	0.161	0.185
A1	1.25	1.40	0.049	0.055
b	0.60	0.90	0.023	0.035
C	0.40	0.70	0.016	0.027
D	15.20	16.00	0.598	0.630
D1	5.90	6.60	0.232	0.259
E	9.70	10.30	0.382	0.405
L	12.80	15.00	0.504	0.590
L1	2.79	3.30	0.110	0.130
R	3.50	3.80	0.138	0.149
T	2.70	3.00	0.106	0.118
Q	2.20	2.60	0.086	0.102
L2		3.00		0.118

Ordering information

Part number	Package	Marking	Packing	Quantity
ADM200N06	TO-220C	ADM200N06	Tube	50pcs